

CALL FOR PAPERS

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SUBMISSION PROCESS & DEADLINES

July 1, 2018
Paper Submission Deadline

August 1, 2018
Notification of Acceptance

August 15, 2018
Submission of Camera Ready Version

August 31, 2018
Registration

DALIAN, CHINA



Paper Submission

Papers are being solicited on all aspects of multimodal haptic audio visual virtual environment technologies and related haptic applications, including but not limited to:

- Tactile Internet
- Haptic and visual computing
- Affective computing
- Haptic sensors and renderer
- Haptic game interfaces
- Multimodal perception and psychophysics
- Augmented and virtualized reality
- Haptic Codes (Kinesthetic & Tactile)
- Tele-haptics and tele-operation
- Hapto-audio-visual systems and applications
- Hapto-surgical/medical systems
- Object modeling
- Soft computing techniques
- Multi-sensor data fusion
- Neuroscience of touch
- Human-computer interaction

Authors of accepted papers must register for the Conference and attend to present the ir papers. All accepted papers presented at the conference will be submitted for publication to IEEE Xplore, reporting the following statement: "This full text paper was peer-reviewed at the direction of IEEE IMS prior to the acceptance and publication".

Authors of accepted IEEE HAVE papers can extend and submit to IEEE Transactions on Instrumentation and Measurement -TIM - (<http://bit.ly/2s5ejZq>) , within 2 months after the conference, i.e. by December 24, 2018.

Submit your paper (4-6 pages) electronically using the web submission form available at <http://have2018.ieee-ims.org>